#### 505917745 02/14/2020

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
YOUNGDAE LEE	01/14/2020
SANGWON KIM	01/14/2020

### **RECEIVING PARTY DATA**

Name:	LG ELECTRONICS INC.
Street Address:	128, YEOUI-DAERO, YEONGDEUNGPO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	07336

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16790633

## CORRESPONDENCE DATA

Fax Number: (213)623-2211

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2136232221 Email: patent@lhlaw.com

Correspondent Name: LEE, HONG, DEGERMAN, KANG & WAIMEY

Address Line 1: 660 S. FIGUEROA STREET

Address Line 2: **SUITE 2300** 

Address Line 4: LOS ANGELES, CALIFORNIA 90017

ATTORNEY DOCKET NUMBER:	2101-72058
NAME OF SUBMITTER:	JUSTIN D. LEE
SIGNATURE:	/Justin D. Lee/
DATE SIGNED:	02/14/2020

**Total Attachments: 2** 

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> **PATENT** REEL: 051821 FRAME: 0777 505917745

#### **ASSIGNMENT**

For valuable consideration, the receipt of which we acknowledge, and intending to be
bound legally, we, LEE, Youngdae and KIM, Sangwon, each individually assign to LG
ELECTRONICS INC., a corporation formed under the laws of Republic of Korea, and having a
principal place of business at 128, Yeoui-daero, Yeongdeungpo-gu, Seoul 07336 Republic of
Korea, , and its successors, transferees, and assignees (collectively the "Assignee"), all of our
individual and joint right, title, and interest throughout the world in the subject matter (the
"Subject Matter") of a patent application that names us as inventors, is titled "MULTIPLE
ACCESSES FOR FAST CONNECTION REESTABLISHMENT," and was filed in the United
States Patent and Trademark Office on, as application
(the "Application").

This Assignment assigns (a) the Application and all other applications that may be made for, and all patents, utility models, design registrations, and other rights of exclusion and inventors' certificates for, any of the Subject Matter (collectively the "Applications and Granted Rights") in every country or region, (b) the right to claim priority based on and the benefit of the filing date of any of the Applications and Granted Rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other applicable treaties or conventions, and (c) the right to pursue, collect, and retain in the Assignee's name or otherwise, damages and any other remedies arising from any past, present, or future infringement of the Subject Matter, the Applications and Granted Rights, and any other rights assigned by this Assignment.

We authorize the Assignee to apply for and pursue protection for any or all of the Subject Matter, the Applications and Granted Rights, and any other rights assigned by this Assignment in all countries, regions, and territories of the world, in our names or in the Assignee's name.

We represent and warrant that we have the right and power to make this Assignment and that we have not made and will not make any other assignment that conflicts with this Assignment.

We will communicate to the Assignee (or at the request of the Assignee to other parties) all known facts in any form relating to the Subject Matter, will execute and provide all oaths and declarations, statements, testimony, assignments, powers of attorney, applications, and

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**RECORDED: 02/14/2020** 

documents, and will perform all other lawful acts necessary or desirable to secure fully to the Assignee the rights, titles, and interests assigned by this Assignment.

Young Das lee Otto

LEE, Youngdae

Date: \_\_\_\_\_\_\_

SangWon Kin 1491
KIM, Sangwon

Date: 2020-01-14

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